

S/N 09/945535



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kie Y. Ahn et al. Examiner: David S. Blum
Serial No.: 09/945535 Group Art Unit: 2813
Filed: August 30, 2001 Docket: 1303.026US1
Title: HIGHLY RELIABLE AMORPHOUS HIGH-K GATE OXIDE ZrO₂

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 *et. seq.*, the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicants respectfully request that this Supplemental Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicants request that a copy of the 1449 form, initialed as being considered by the Examiner, be returned to the Applicants with the next official communication.

Pursuant to 37 C.F.R. §1.97(c)(2), Applicants have included the fee of \$180.00 as set forth in 37 C.F.R. §1.17(p). Please charge any additional fees or credit any overpayment to Deposit Account No. 19-0743.

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The Examiner is invited to contact the Applicants' Representative at the below-listed telephone number if there are any questions regarding this communication.

Respectfully submitted,

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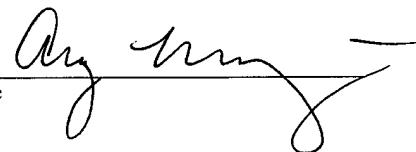
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Signature



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**INFORMATION DISCLOSURE
STATEMENT BY APPLICANT**
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| Application Number | 09/945535 |
| Filing Date | August 30, 2001 |
| First Named Inventor | Ahn, Kie |
| Group Art Unit | 2813 |
| Examiner Name | Blum, David |

Sheet 1 of 8 Attorney Docket No: 1303.026US1

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| Examiner Name | | Blum, David | |
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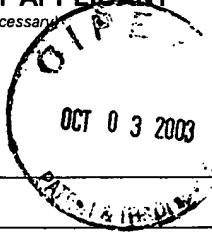
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| Examiner Name | Blum, David |

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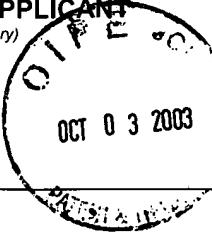
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